Dual 4-input multiplexer; 3-state Rev. 1 — 17 July 2012

**Product data sheet** 

#### 1. **General description**

The 74HC253-Q100; 74HCT253-Q100 are high-speed Si-gate CMOS devices and are pin compatible with Low-power Schottky TTL (LSTTL).

The 74HC253-Q100; 74HCT253-Q100 provides a dual 4-input multiplexer with 3-state outputs which selects 2 bits of data from up to four sources selected by common data select inputs (S0, S1). The two 4-input multiplexer circuits have individual active LOW output enable inputs  $(1\overline{OE}, 2\overline{OE})$ .

The 74HC253-Q100 and 74HCT253-Q100 are the logic implementation of a 2-pole, 4-position switch, where the position of the switch is determined by the logic levels applied to S0 and S1. The outputs are forced to a high-impedance OFF-state when nOE is HIGH.

The logic equations for the outputs are:

$$1Y = 1\overline{OE} \bullet (110 \bullet \overline{S1} \bullet \overline{S0} + 111 \bullet \overline{S1} \bullet S0 + 112 \bullet S1 \bullet \overline{S0} + 113 \bullet S1 \bullet S0)$$

 $2Y = 2\overline{OE} \bullet (2I0 \bullet \overline{S1} \bullet \overline{S0} + 2I1 \bullet \overline{S1} \bullet S0 + 2I2 \bullet S1 \bullet \overline{S0} + 2I3 \bullet S1 \bullet S0)$ 

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

#### **Features and benefits** 2.

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - Specified from –40 °C to +85 °C and from –40 °C to +125 °C
- Non-inverting data path
- 3-state outputs interface directly with system bus
- Complies with JEDEC standard no. 7A
- Common select inputs
- Separate output enable inputs
- Input levels:
  - For 74HC253-Q100: CMOS level
  - For 74HCT253-Q100: TTL level
- ESD protection:
  - MIL-STD-883, method 3015 exceeds 2000 V
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)



Dual 4-input multiplexer; 3-state

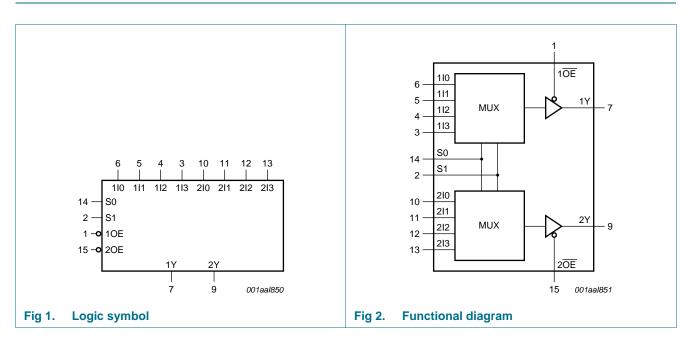
# 3. Applications

- Data selectors
- Data multiplexers

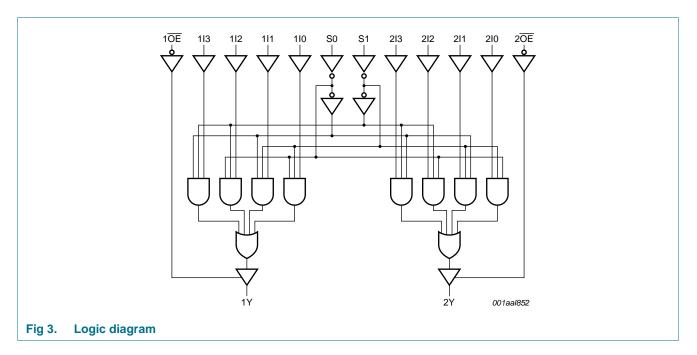
# 4. Ordering information

Table 1.         Ordering information										
Type number Package										
	Temperature range	Name	Description	Version						
74HC253D-Q100	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width	SOT109-1						
74HCT253D-Q100			3.9 mm							

# 5. Functional diagram

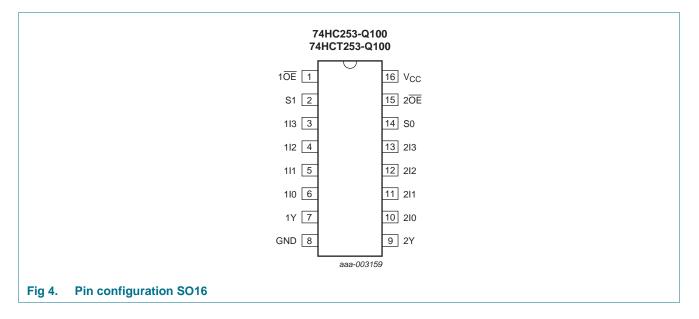


Dual 4-input multiplexer; 3-state



## 6. Pinning information

### 6.1 Pinning



Dual 4-input multiplexer; 3-state

### 6.2 Pin description

Table 2. Pin des	cription	
Symbol	Pin	Description
1 <u>0E</u> , 2 <u>0E</u>	1, 15	output enable inputs (active LOW)
S0, S1	14, 2	data select inputs
110, 111, 112, 113	6, 5, 4, 3	data inputs source 1
1Y	7	multiplexer output source 1
GND	8	ground (0 V)
2Y	9	multiplexer output source 2
210, 211, 212, 213	10, 11, 12, 13	data inputs source 2
V <sub>CC</sub>	16	supply voltage

# 7. Functional description

#### Table 3.Function table<sup>[1]</sup>

select In	puts	data inp	uts			output enable	output
S0	S1	nl0	nl1	nl2	nl3	nOE	nY
х	Х	Х	Х	Х	Х	Н	Z
L	L	L	Х	Х	Х	L	L
L	L	Н	Х	Х	Х	L	Н
Н	L	Х	L	Х	Х	L	L
Н	L	Х	Н	Х	Х	L	Н
L	Н	Х	Х	L	Х	L	L
L	Н	Х	Х	Н	Х	L	Н
Н	Н	Х	Х	Х	L	L	L
Н	Н	Х	Х	Х	Н	L	Н

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

### 8. Limiting values

#### Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	$V_{\rm I} < -0.5$ V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u> _	±20	mA
I <sub>OK</sub>	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u> _	±50	mA
I <sub>O</sub>	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	-	±35	mA
I <sub>CC</sub>	supply current		-	70	mA
I <sub>GND</sub>	ground current		-70	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C

#### Table 4. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
P <sub>tot</sub>	total power dissipation	$T_{amb}$ = -40 °C to +125 °C			
		SO16 package	[2] _	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2]  $P_{tot}$  derates linearly with 8 mW/K above 70 °C.

### 9. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC2	53-Q100		74HCT	253-Q10	0	Unit
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V
		$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V

### **10. Static characteristics**

#### Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC25	3-Q100									
V <sub>IH</sub>		$V_{CC} = 2.0 V$	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	$V_{CC} = 4.5 V$	3.15	2.4	-	3.15	-	3.15	-	V
		$V_{CC} = 6.0 V$	4.2	3.2	-	4.2	-	4.2	-	V
V <sub>IL</sub>	L LOW-level	$V_{CC} = 2.0 V$	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	$V_{CC} = 4.5 V$	-	2.1	1.35	-	1.35	-	1.35	V
		$V_{CC} = 6.0 V$	-	2.8	1.8	-	1.8	-	1.8	V
V <sub>OH</sub>	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_O = -20 \ \mu\text{A}; \ V_{CC} = 2.0 \ \text{V}$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_O = -20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_O = -20 \ \mu\text{A}; \ V_{CC} = 6.0 \ \text{V}$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O}$ = -6.0 mA; $V_{CC}$ = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O}$ = -7.8 mA; $V_{CC}$ = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V

Dual 4-input multiplexer; 3-state

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to	o +125 °C	Un
			Min	Тур	Max	Min	Max	Min	Max	
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = 20 \ \mu A; V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 20 \ \mu A; V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 20 \ \mu A; V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O}$ = 6.0 mA; $V_{CC}$ = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I <sub>O</sub> = 7.8 mA; V <sub>CC</sub> = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	±0.1	-	±1.0	-	±1.0	μA
I <sub>OZ</sub>	OFF-state output current		-	-	±0.5	-	±5.0	-	±10.0	μA
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0$ V	-	-	8.0	-	80	-	160	μA
Cı	input capacitance		-	3.5	-					pF
74HCT2	53-Q100									
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC}$ = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	$V_{CC}$ = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
0	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -6 mA	3.98	4.32	-	3.84	-	3.7	-	V
V <sub>OL</sub>	LOW-level	$V_{I}$ = $V_{IH}$ or $V_{IL};V_{CC}$ = 4.5 V								
	output voltage	I <sub>O</sub> = 20 μA	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 6.0 \text{ mA}$	-	0.15	0.26	-	0.33	-	0.4	V
lı	input leakage current	$V_1 = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±0.1	-	±1.0	-	±1.0	μA
I <sub>OZ</sub>	OFF-state output current	$V_{I} = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 5.5$ V; $V_{O} = V_{CC}$ or GND per input pin; other inputs at $V_{CC}$ or GND; $I_{O} = 0$ A	-	-	±0.5	-	±5.0	-	±10	μΑ
I <sub>CC</sub>	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC} \text{ or } GND; \ I_{O} = 0 \ A; \\ V_{CC} = 5.5 \ V \end{array}$	-	-	8.0	-	80	-	160	μA
∆l <sub>CC</sub>	additional supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC} - 2.1 \text{ V};\\ \text{other inputs at } V_{CC} \text{ or GND};\\ V_{CC} = 4.5 \text{ V to 5.5 V};\\ I_{O} = 0 \text{ A} \end{array}$								
		per input pin; 1In, 2In inputs	-	40	144	-	180	-	196	μA
		per input pin; nOE input	-	110	396	-	495	-	539	μA
		per input pin; Sn input	-	110	396	-	495	-	539	μA
Cı	input capacitance		-	3.5	-					pF

#### Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Product data sheet

Dual 4-input multiplexer; 3-state

# **11. Dynamic characteristics**

#### Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); For test circuit see <u>Figure 7</u>.

Symbol	Parameter	Conditions		25	°C	–40 °C to +85 °C	–40 °C to +125 °C	Unit
				Тур	Max	Max	Max	
74HC253	3-Q100							
pd	propagation delay	1In to 1Y or 2In to 2Y; see <u>Figure 5</u>	<u>[1]</u>					
		$V_{CC} = 2.0 V$		55	175	220	265	ns
		$V_{CC} = 4.5 V$		20	35	44	53	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		17	-	-	-	ns
		$V_{CC} = 6.0 V$		16	30	37	45	ns
		Sn to nY; see Figure 5						
		$V_{CC} = 2.0 V$		58	175	220	265	ns
		$V_{CC} = 4.5 V$		21	35	44	53	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		18	-	-	-	ns
		$V_{CC} = 6.0 V$		17	30	37	45	ns
en	enable time	nOE to nY; see Figure 6	[2]					
		$V_{CC} = 2.0 V$		30	100	125	150	ns
		$V_{CC} = 4.5 V$		11	20	25	30	ns
		$V_{CC} = 6.0 V$		9	17	21	26	ns
t <sub>dis</sub> disable time	disable time	nOE to nY; see Figure 6	[3]					
		$V_{CC} = 2.0 V$		41	150	190	225	ns
		$V_{CC} = 4.5 V$		15	30	38	45	ns
		$V_{CC} = 6.0 V$		12	26	33	38	ns
·t	transition time	see Figure 5	[4]					
		$V_{CC} = 2.0 V$		14	60	75	90	ns
		$V_{CC} = 4.5 V$		5	12	15	18	ns
		$V_{CC} = 6.0 V$		4	10	13	15	ns
C <sub>PD</sub>	power dissipation capacitance	per multiplexer; $V_1 = GND$ to $V_{CC}$	<u>[5]</u>	55	-			pF
74HCT2	53-Q100							
t <sub>pd</sub>	propagation delay	1In to 1Y or 2In to 2Y; see <u>Figure 5</u>	<u>[1]</u>					
		$V_{CC} = 4.5 V$		20	38	48	57	ns
		$V_{CC}$ = 5.0 V; C <sub>L</sub> = 15 pF		17	-	-		ns
		Sn to nY; see Figure 5						
		V <sub>CC</sub> = 4.5 V		22	40	50	60	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		19	-			ns
t <sub>en</sub>	enable time	$n\overline{OE}$ to nY; V <sub>CC</sub> = 4.5 V; see <u>Figure 6</u>	[2]	14	30	38	45	ns

Dual 4-input multiplexer; 3-state

Symbol	Parameter	Conditions		25	25 °C –40 °C to +85 °C		–40 °C to +125 °C	Unit
				Тур	Max	Max	Max	
t <sub>dis</sub>	disable time	$n\overline{OE}$ to nY; V <sub>CC</sub> = 4.5 V; see <u>Figure 6</u>	<u>[3]</u>	13	30	38	45	ns
t <sub>t</sub>	transition time	$V_{CC}$ = 4.5 V; see <u>Figure 5</u>		5	12	15	18	ns
C <sub>PD</sub>	power dissipation capacitance	per multiplexer; $V_I = GND$ to $V_{CC}$	<u>[5]</u>	55	-			pF

#### Table 7. Dynamic characteristics ... continued

. . ~ · · · -

 $[1] \quad t_{pd} \text{ is the same as } t_{PHL}, \, t_{PLH}.$ 

[2]  $t_{en}$  is the same as  $t_{PZH}$ ,  $t_{PZL}$ .

[3]  $t_{dis}$  is the same as  $t_{PHZ}$ ,  $t_{PLZ}$ .

- [4]  $t_t$  is the same as  $t_{THL}$ ,  $t_{TLH}$ .
- [5]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_{D}$  =  $C_{PD} \times V_{CC}{}^{2} \times f_{i} \times N$  +  $\Sigma (C_{L} \times V_{CC}{}^{2} \times f_{o})$  where:

 $f_i$  = input frequency in MHz;

fo = output frequency in MHz;

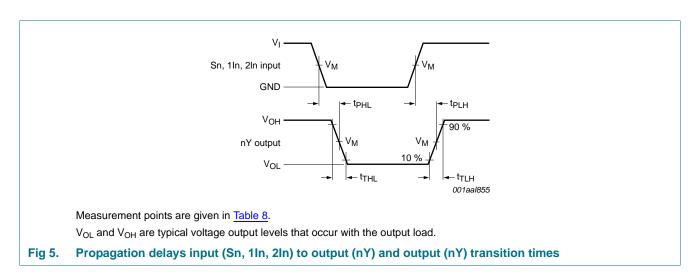
 $C_L$  = output load capacitance in pF;

 $V_{CC}$  = supply voltage in V;

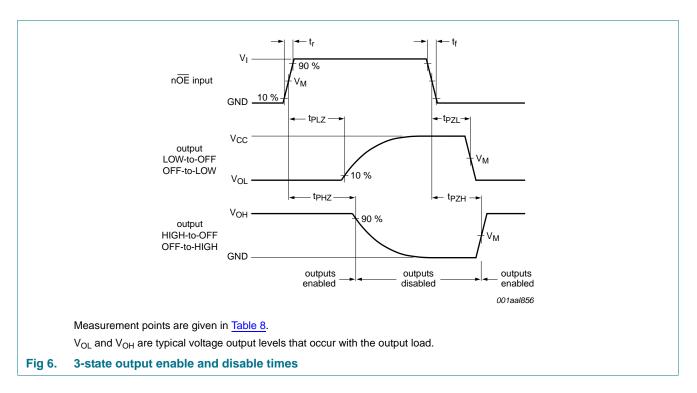
N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_0)$  = sum of outputs.

### 12. Waveforms



Dual 4-input multiplexer; 3-state



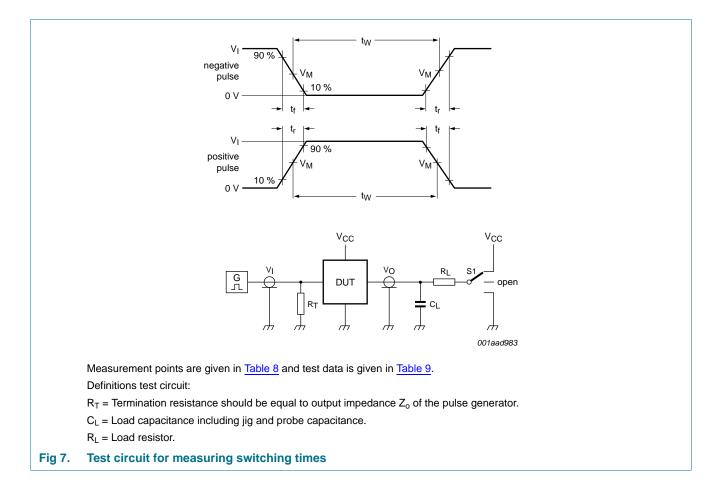
#### Table 8.Measurement points

Туре	Input	Output
	V <sub>M</sub>	V <sub>M</sub>
74HC253-Q100	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>
74HCT253-Q100	1.3 V	1.3 V

### **NXP Semiconductors**

# 74HC253-Q100; 74HCT253-Q100

### Dual 4-input multiplexer; 3-state

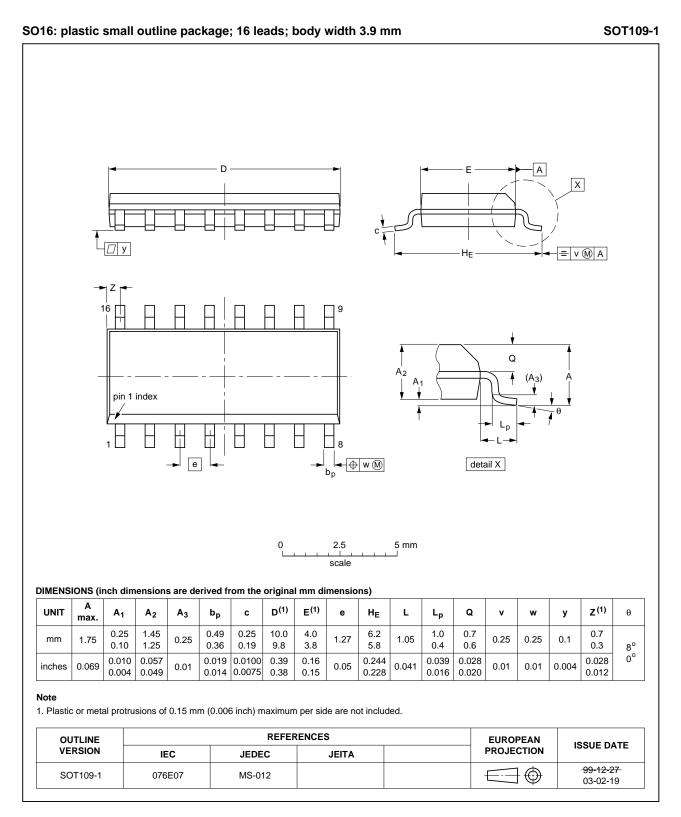


#### Table 9. Test data

Туре	Input		Load		Switch position		
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PHL</sub> , t <sub>PLH</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>
74HC253-Q100	V <sub>CC</sub>	6 ns	50 pF	1 kΩ	open	GND	V <sub>CC</sub>
74HCT253-Q100	3 V	6 ns	50 pF	1 kΩ	open	GND	V <sub>CC</sub>

Dual 4-input multiplexer; 3-state

## 13. Package outline



#### Fig 8. Package outline SOT109-1 (SO16)

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74HC\_HCT253\_Q100

Dual 4-input multiplexer; 3-state

# 14. Abbreviations

Description
Complementary Metal Oxide Semiconductor
Device Under Test
ElectroStatic Discharge
Human Body Model
Machine Model
Transistor-Transistor Logic
Military

# **15. Revision history**

Table 11.         Revision history	1. Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
74HC_HCT253_Q100 v.1	20120717	Product data sheet	-	-	

# 16. Legal information

### 16.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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